

RD50

from Experiment perspective

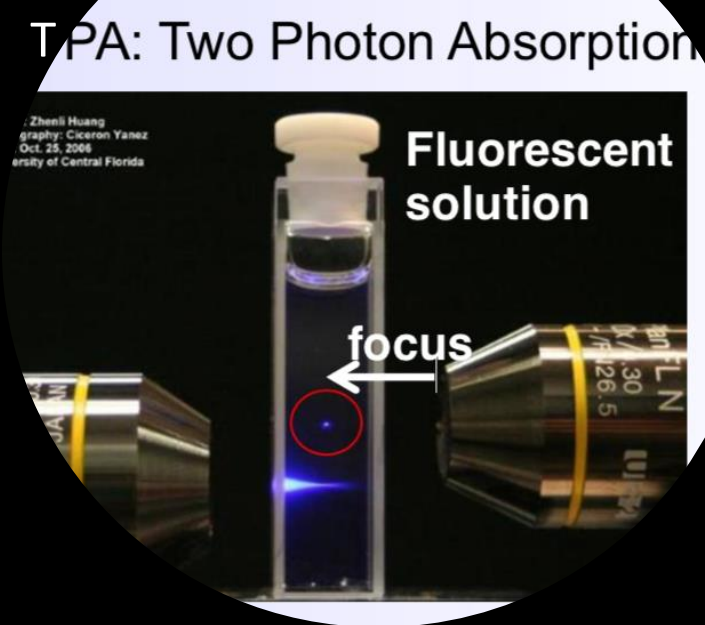
Frank Hartmann – THANKS FOR ALLOWING ME TO TALK HERE

Well, we couldn't have done
without RD50



What did we – THE EXPERIMENTS – get?

- Forum to discuss all
 - Reasonable and crazy ideas
- Recipes
 - What to build
 - How to operate
- Tools





A Forum – a common goal

- Always difficult to understand which R&D effort is RD50 and what is experiment
 - **I consider this perfect.** It means we are sharing information on successes and failures
- I am unable to decide what is most efficient
 - The sessions with talks
 - The evening get-togethers
 - The coffee breaks
 - Lab visits

Well Ok, I can:
It's the coffee breaks plus the common goal!
I always enjoyed the clear and frank chats

Recipes

- **For LHC**

- Oxygen is good – Carbon is bad
- p-in-n is OK for Tracker
- n-in-n is OK for Vertex (*oxygenated n-bulk*)

- **For HL-LHC**


- Oxygen is good – Carbon is also good at some places
- n-in-p is great
 - optimise thickness
- 3D is better
- Precise timing is possible

- **A WISE MAN SAID:**

For p-in-n sensors, the donor removal component of the Hamburg model cannot be described by a simple process $V + P \rightarrow V P$ only. There is something more behind that and we still do not exactly understand what it is.

- **RD50 ALSO CLEARLY TOLD US:**

But, while new materials seem to be more radiation tolerant, a complete evaluation of **each material must be conducted separately for neutron, proton and mixed irradiation**. The correct radiation mixtures at different radii in the experiment should be checked.

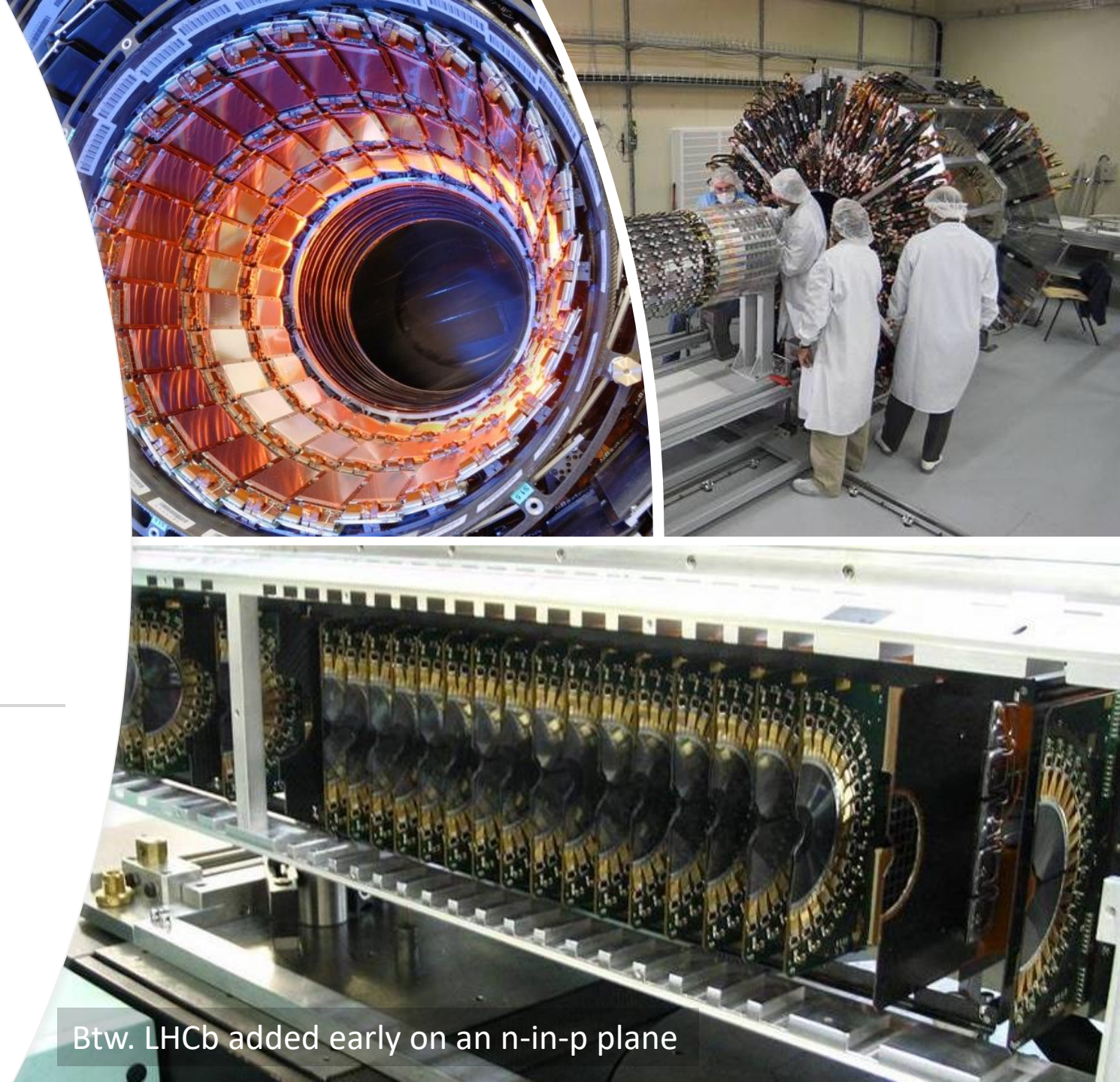


Thank you.
We did that.

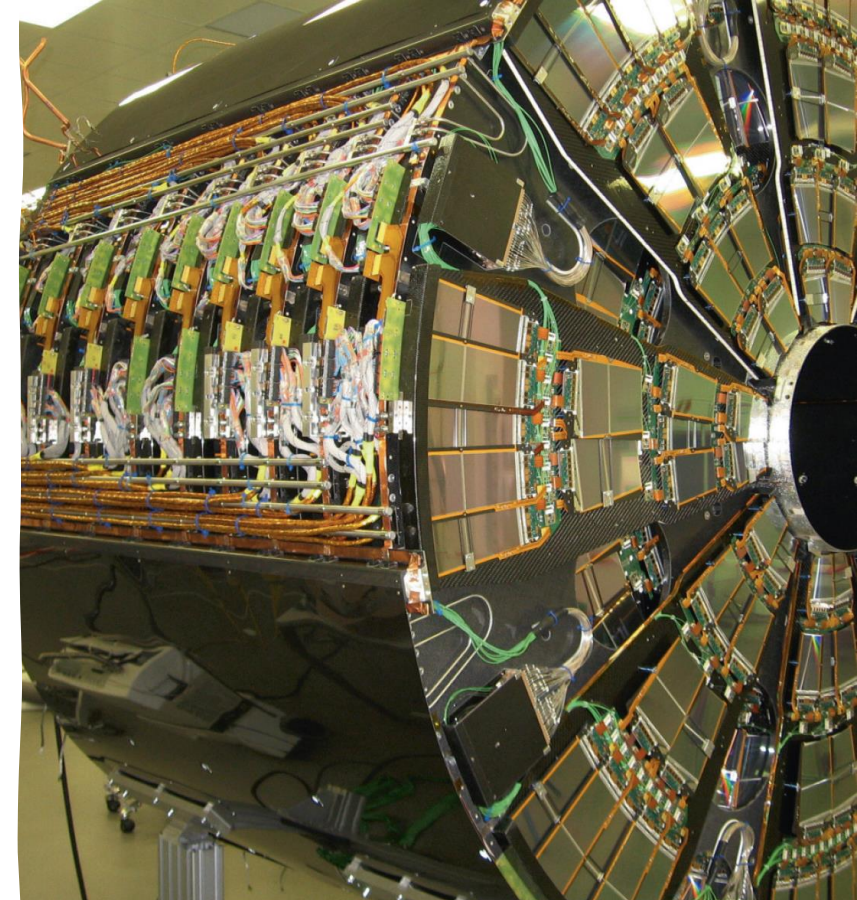
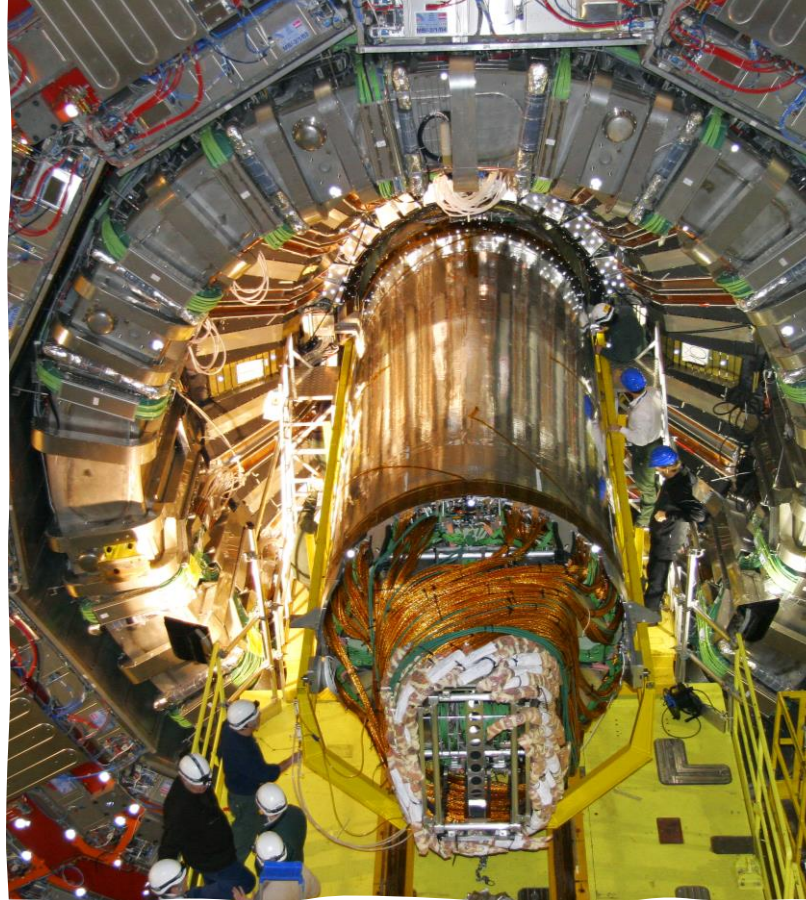
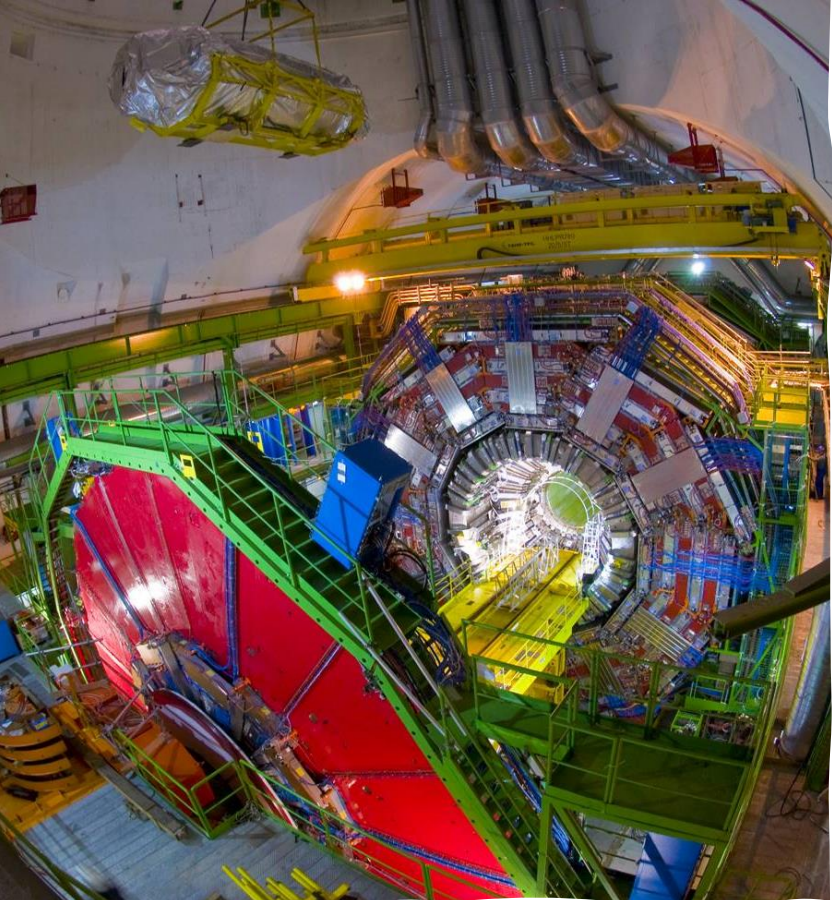
RD50 and
Hamburg Model
said p-in-n is OK
for E14

Seems you are right

$\sim 270\text{m}^2$ proves it

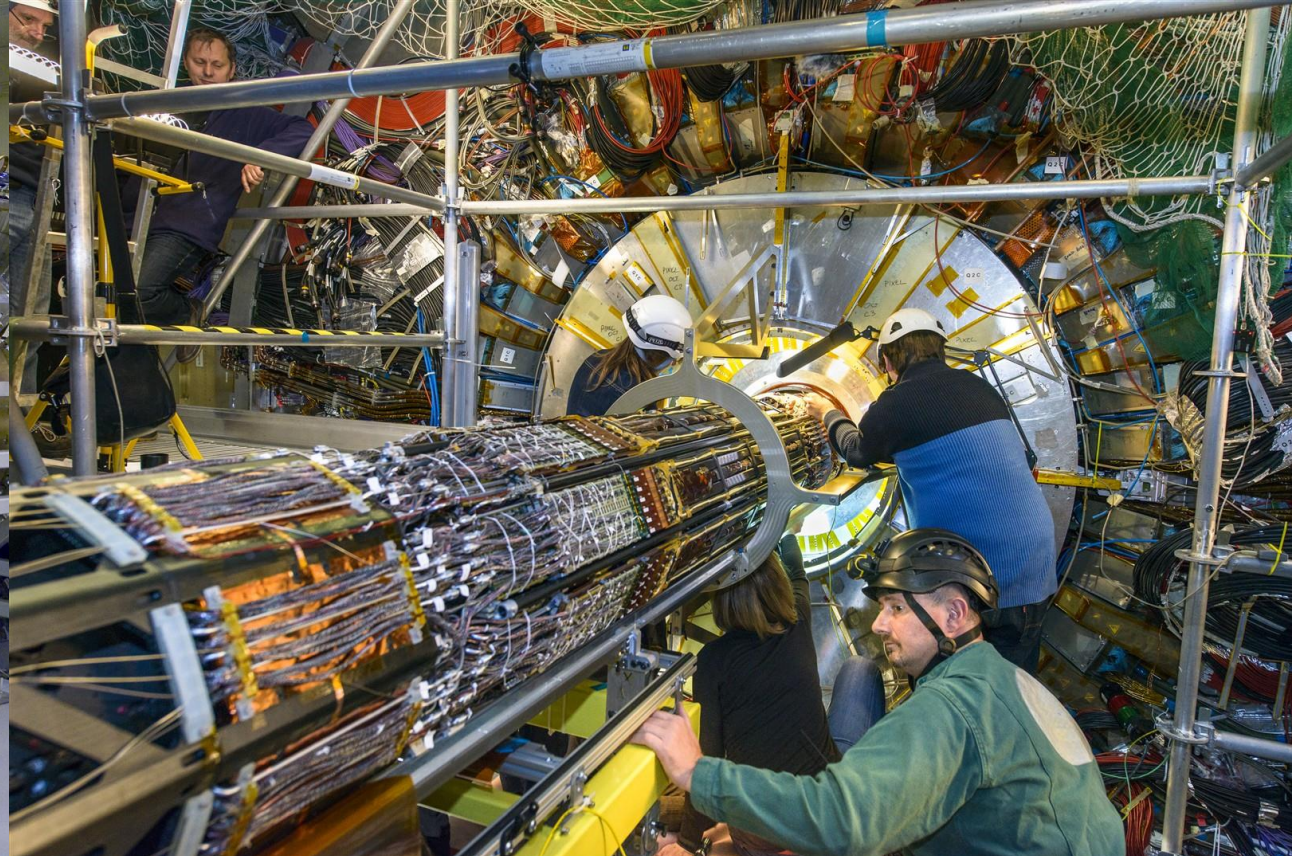
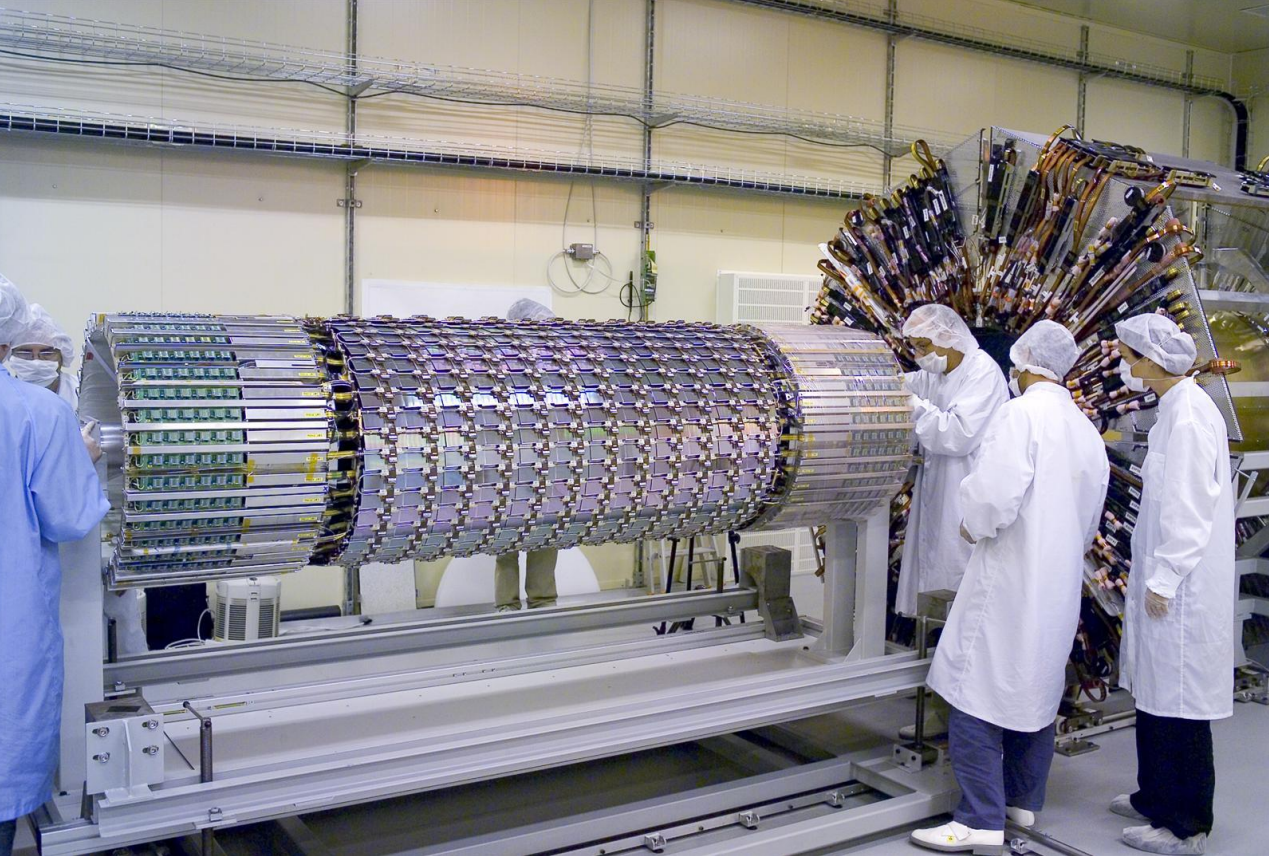


Btw. LHCb added early on an n-in-p plane



The CMS Tracker

- 200 m²
- Strips and pixel detectors
- Operating > 1 decade



The ATLAS Tracker

- 60 m²
- Strips and pixel detectors
- Operating > 1 decade

LHCb until LS2

Strips

n-in-n plus some n-in-p

Detector has accumulated fluence of approximately 7×10^{14} 1MeV n_{eq}/cm^2

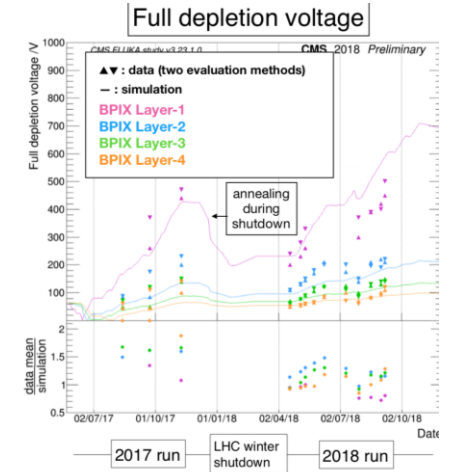
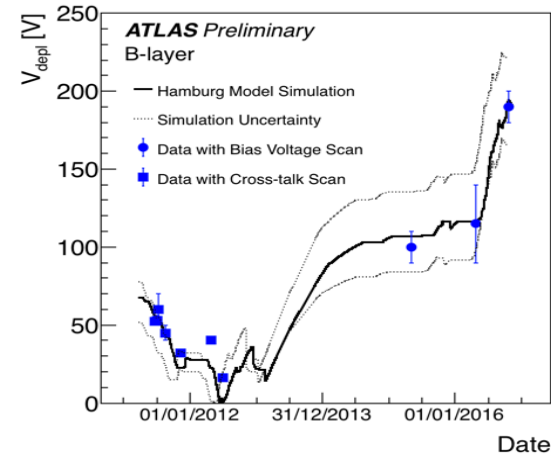
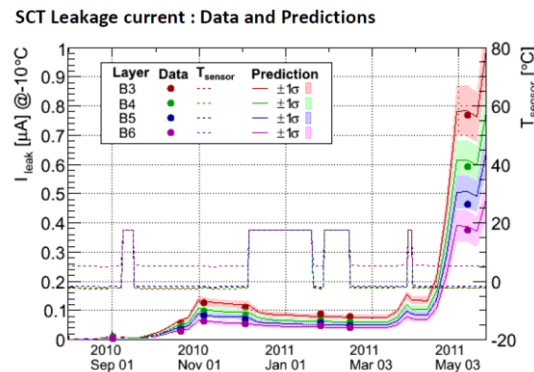
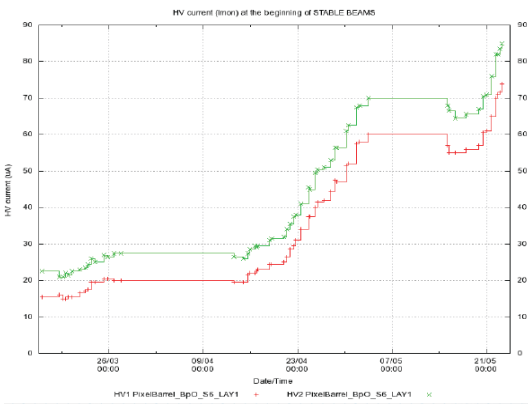
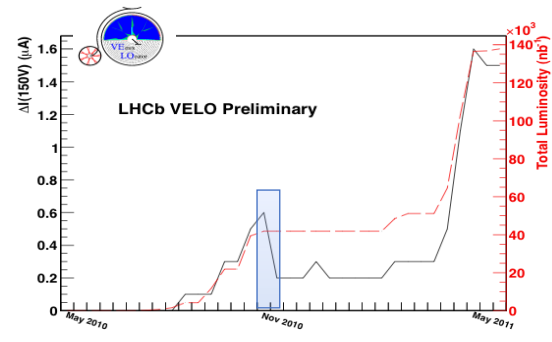
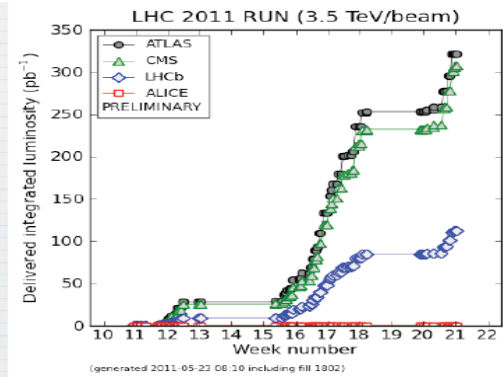
And RD50 followed-up if all is true

19th RD50 workshop, November 2011 at CERN,
especially in the session on **radiation damage observed in HEP experiments**

→ Inter-experiment radiation damage working group

Radiation Damage and Annealing exists

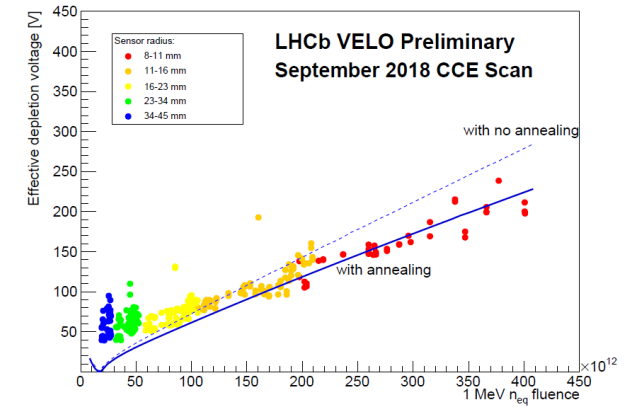
Inter-experiment radiation damage working group



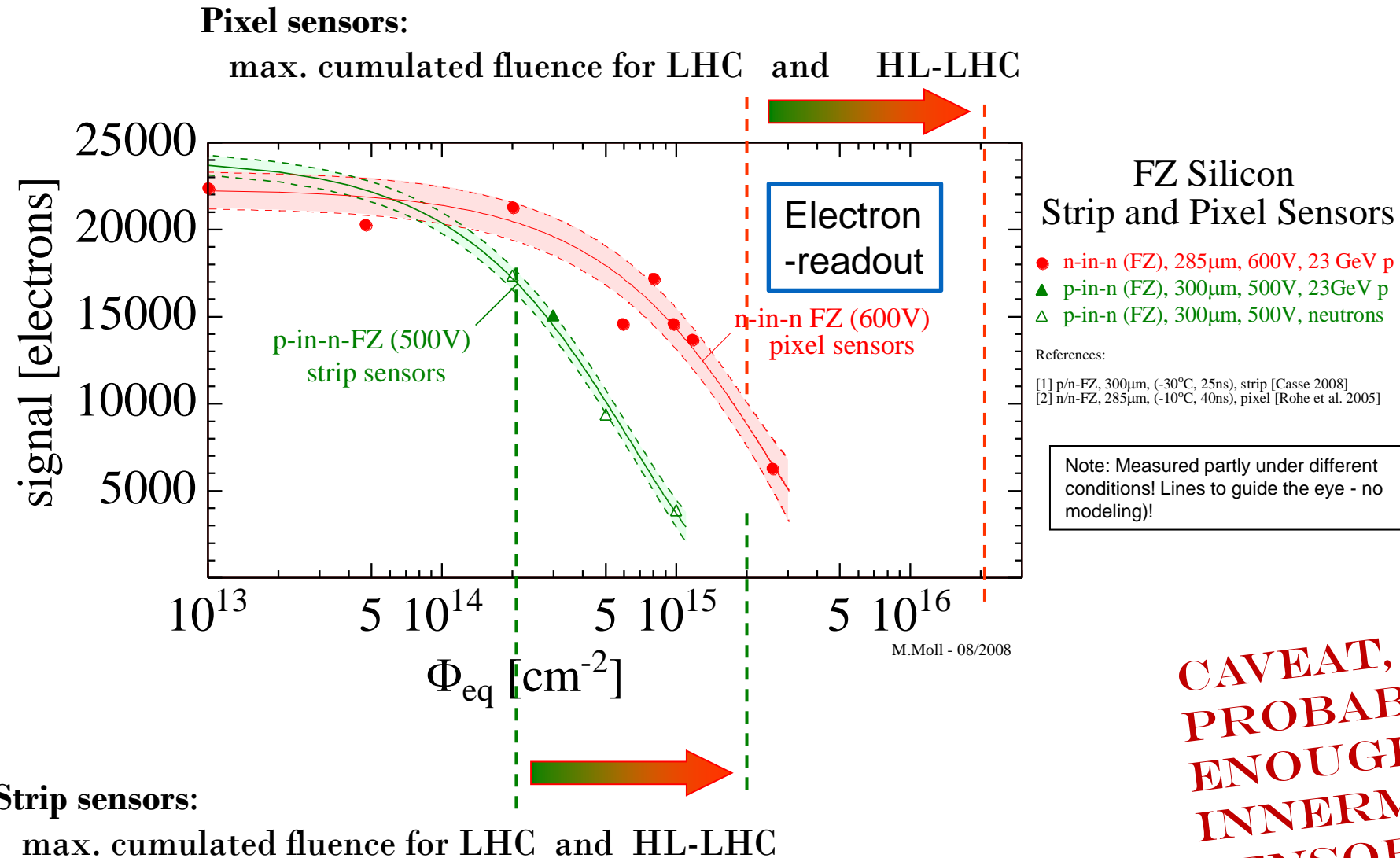
- The Hamburg Model rocks

- Good recipe when to increase bias voltages

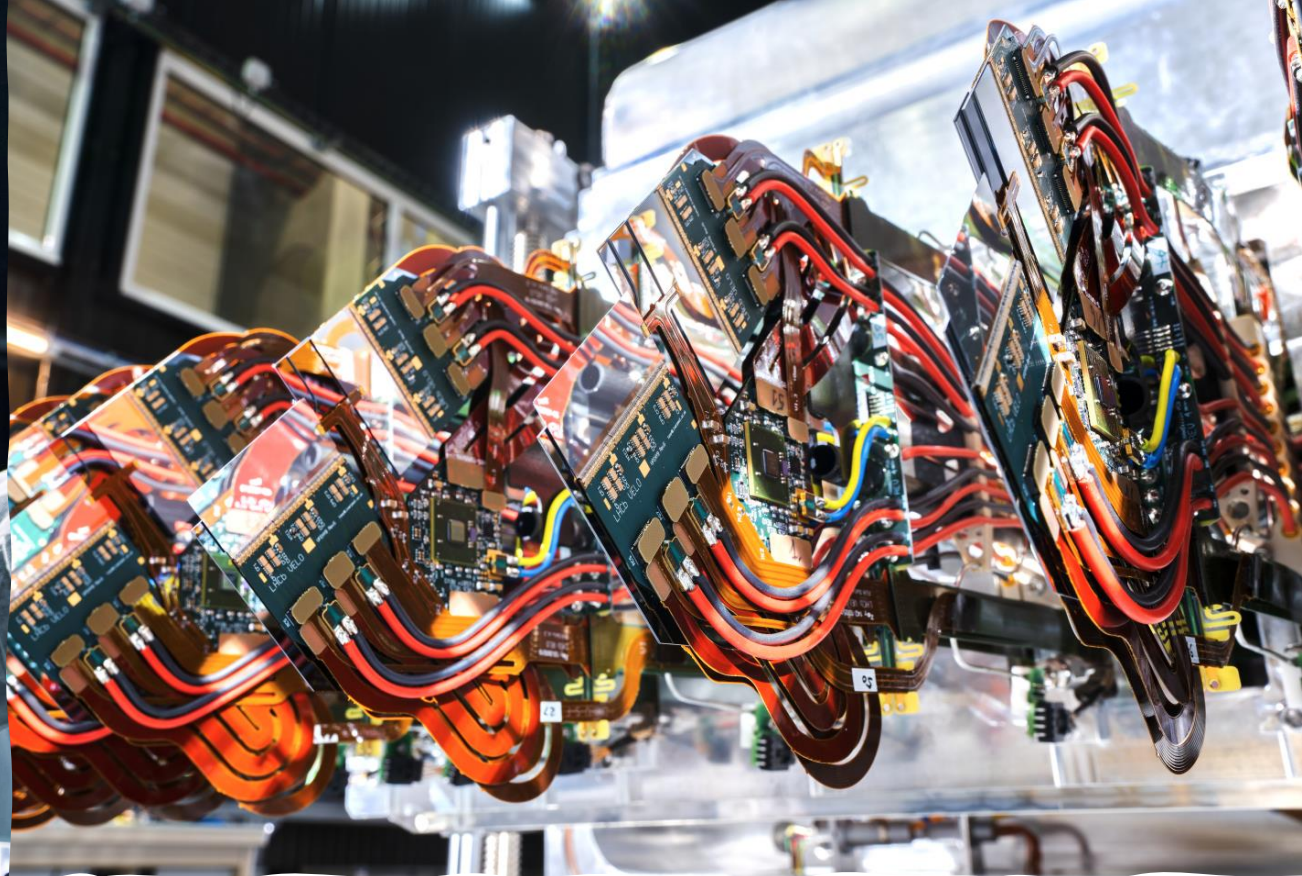
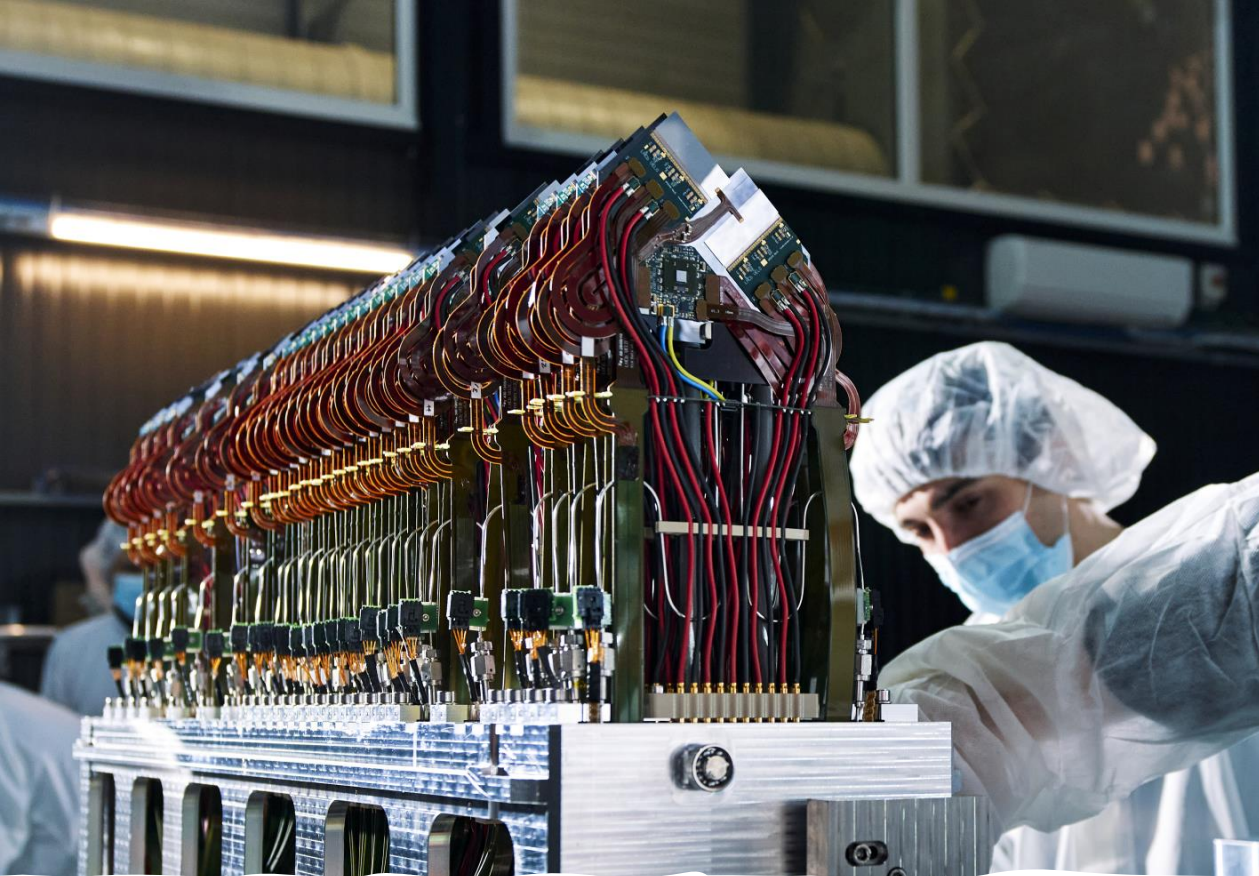
- Parametric description of operation parameters (signal, trapping, current) as a function of fluence and temperature.



Then we learned, we should use 'ELECTRON READOUT'



**CAVEAT,
PROBABLY NOT
ENOUGH FOR
INNERMOST
SENSORS**



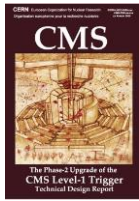
And, LHCb is ahead

- New VEO with n-in-p pixels
 - Exchanged in LS2

HL-LHC – LS3

Ok, now we need

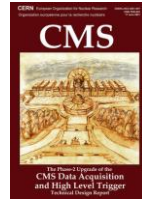
- X*E16
- And precision *timing*



L1-Trigger

<https://cds.cern.ch/record/2714892>

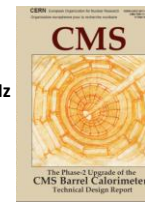
- Tracks in L1-Trigger at 40 MHz
- Particle Flow selection
- 750 kHz L1 output
- 40 MHz data scouting



DAQ & High-Level Trigger

<https://cds.cern.ch/record/2759072>

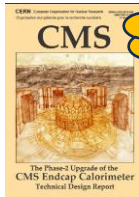
- Full optical readout
- Heterogenous architecture
- 60 TB/s event network
- 7.5 kHz HLT output



Barrel Calorimeters

<https://cds.cern.ch/record/2283187>

- ECAL crystal granularity readout at 40 MHz with precise timing for e/γ at 30 GeV
- ECAL and HCAL new Back-End boards

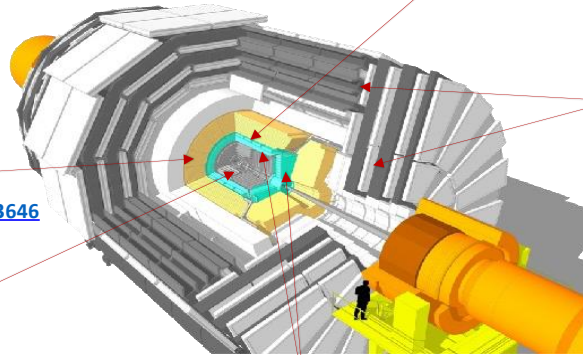


E16

Calorimeter Endcap

<https://cds.cern.ch/record/2293646>

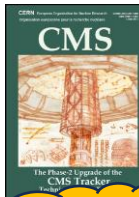
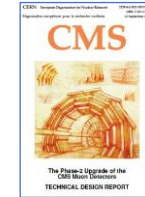
- 3D showers and precise timing
- Si, Scint+SiPM in Pb/W-SS



Muon systems

<https://cds.cern.ch/record/2283189>

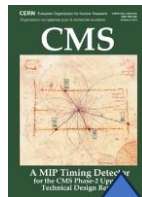
- DT & CSC new FE/BE readout
- RPC back-end electronics
- New GEM/RPC $1.6 < \eta < 2.4$
- Extended coverage to $\eta \approx 3$



Tracker

<https://cds.cern.ch/record/2272264>

- Si-Strip and Pixels increased granularity
- Design for tracking in L1-Trigger
- Extended coverage to $\eta \approx 3.8$



MIP Timing Detector

<https://cds.cern.ch/record/2667167>

Precision timing with:

- Barrel layer: Crystals + SiPMs
- Endcap layer: Low Gain Avalanche Diodes

Beam Radiation Instr. and Luminosity

<http://cds.cern.ch/record/2759074>

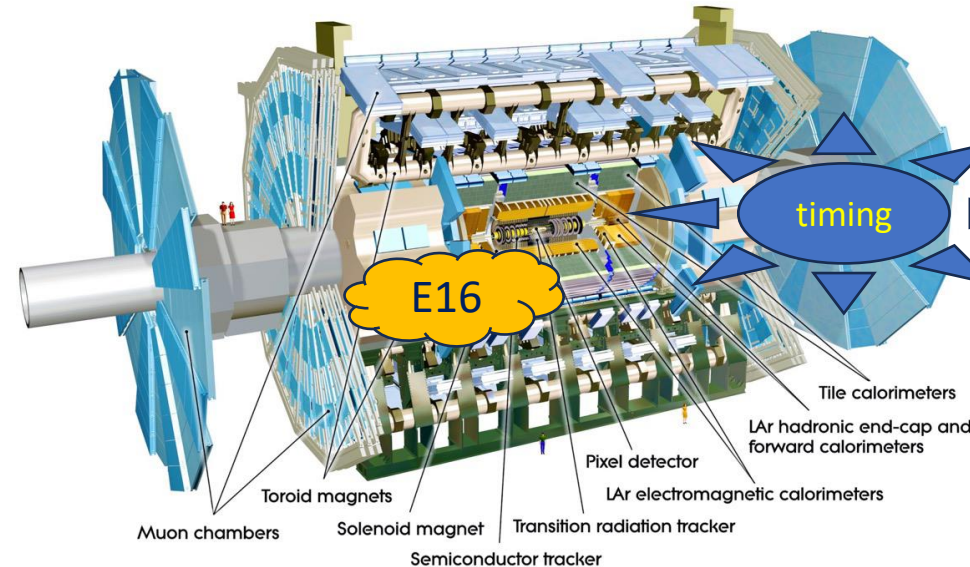
- Beam abort & timing
- Beam-induced background
- Bunch-by-bunch luminosity: 1% offline, 2% online
- Neutron and mixed-field radiation



timing

E16

Let's increase to 1000 m²



E16

timing

Axial field provided by solenoid (2 T) in the central region (momentum measurement)

High-resolution silicon detectors:

- 100 Mio. channels (50 μm x 250 μm)
- 6 Mio. channels (80 μm x 12 cm)

Spatial resolution ~15 μm (in azimuthal direction)

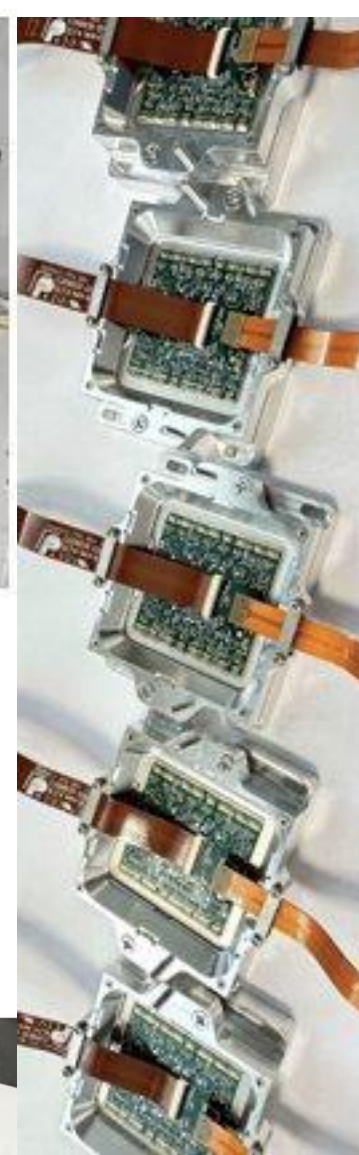
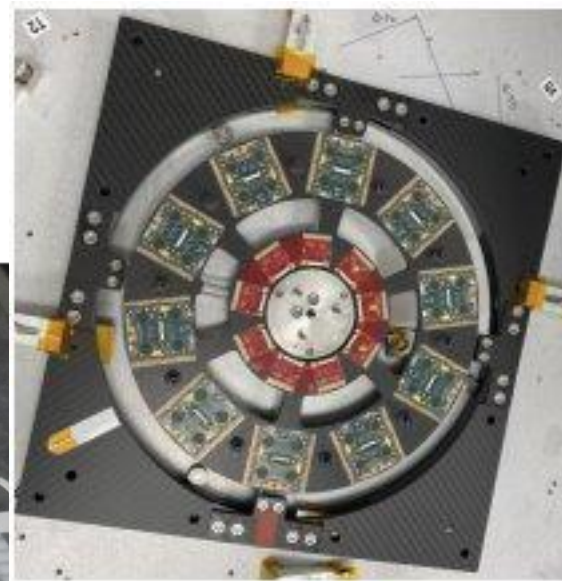
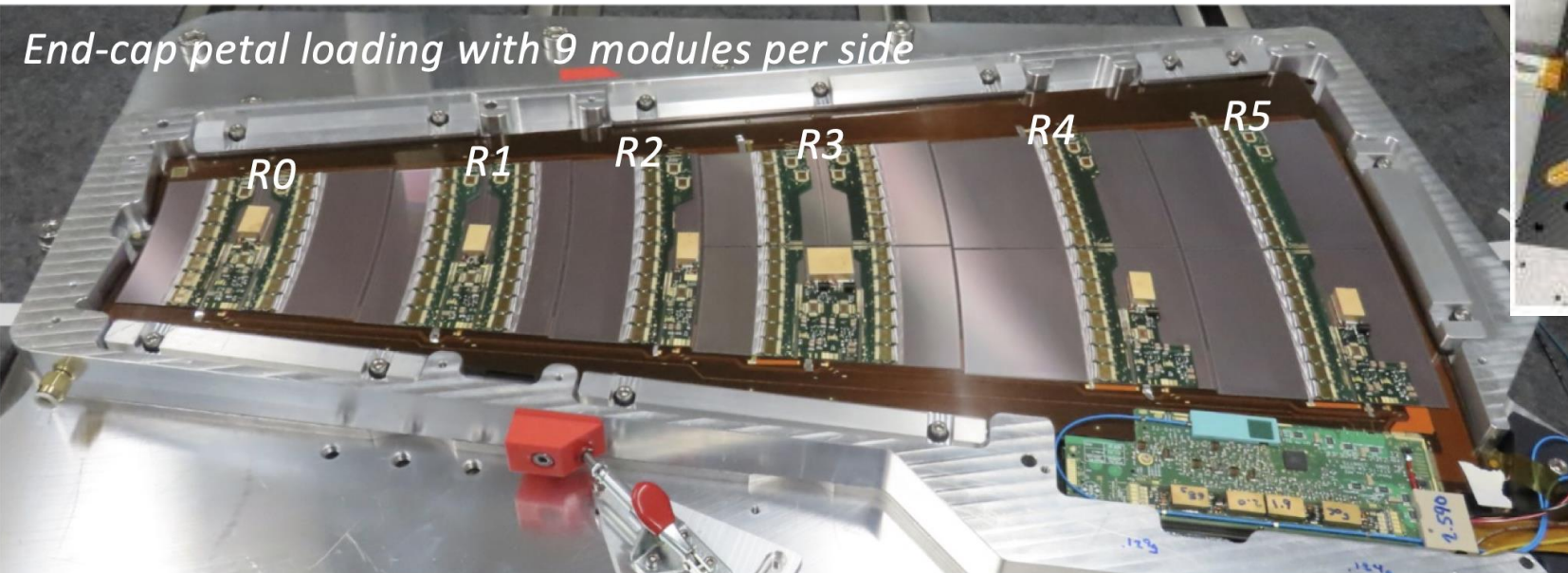
Precise energy measurement down to 1° to the beamline with a calorimeter system

Independent muon spectrometer (superconducting toroidal magnet system)

Ultra-fast custom electronics and high-performance computers filter the collisions: only 1 out of 30,000 collisions is kept

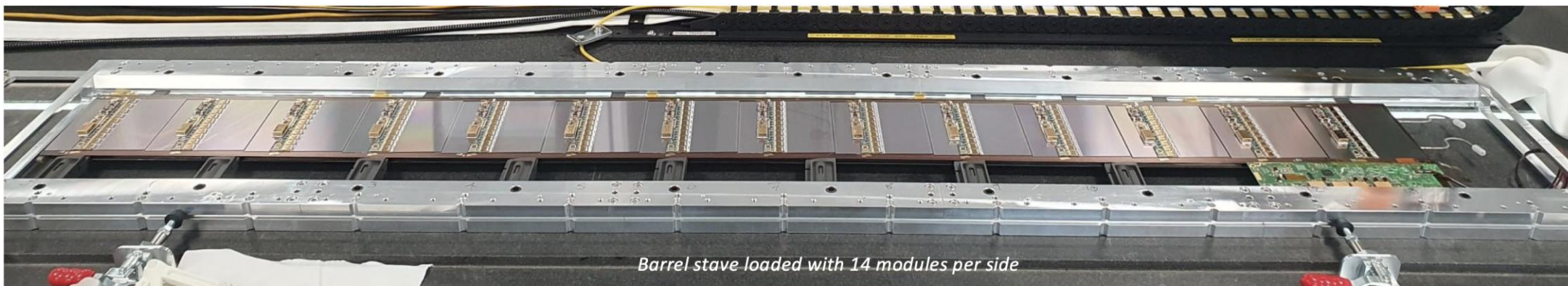
ATLAS Phase II

End-cap petal loading with 9 modules per side



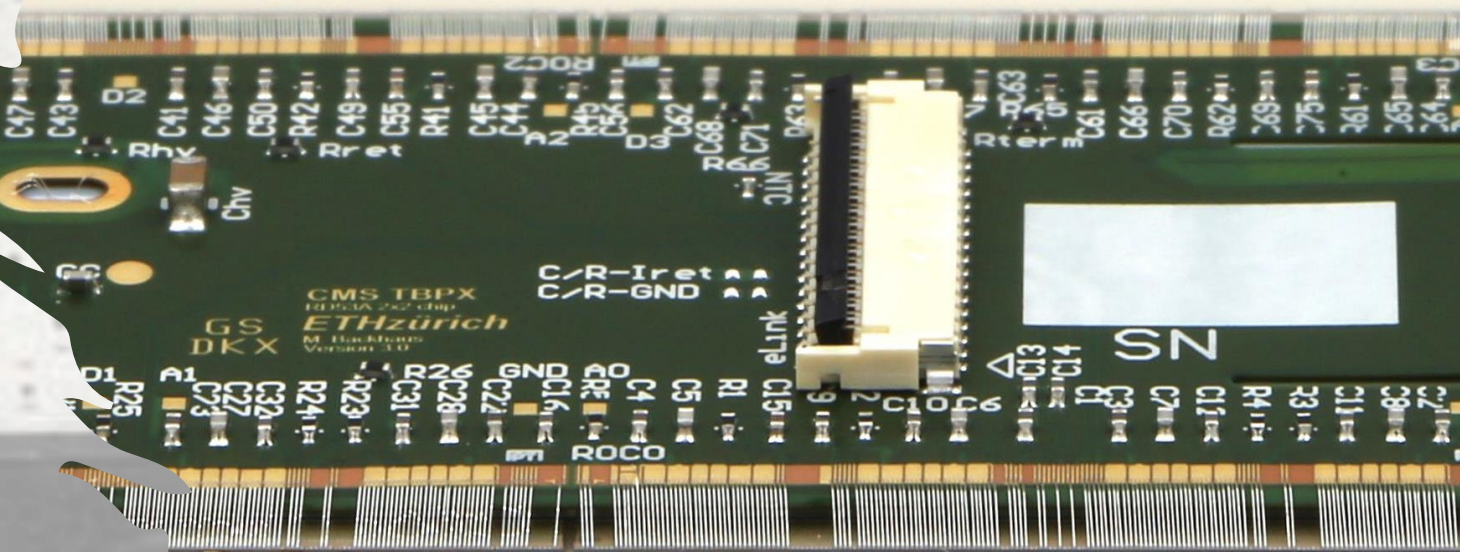
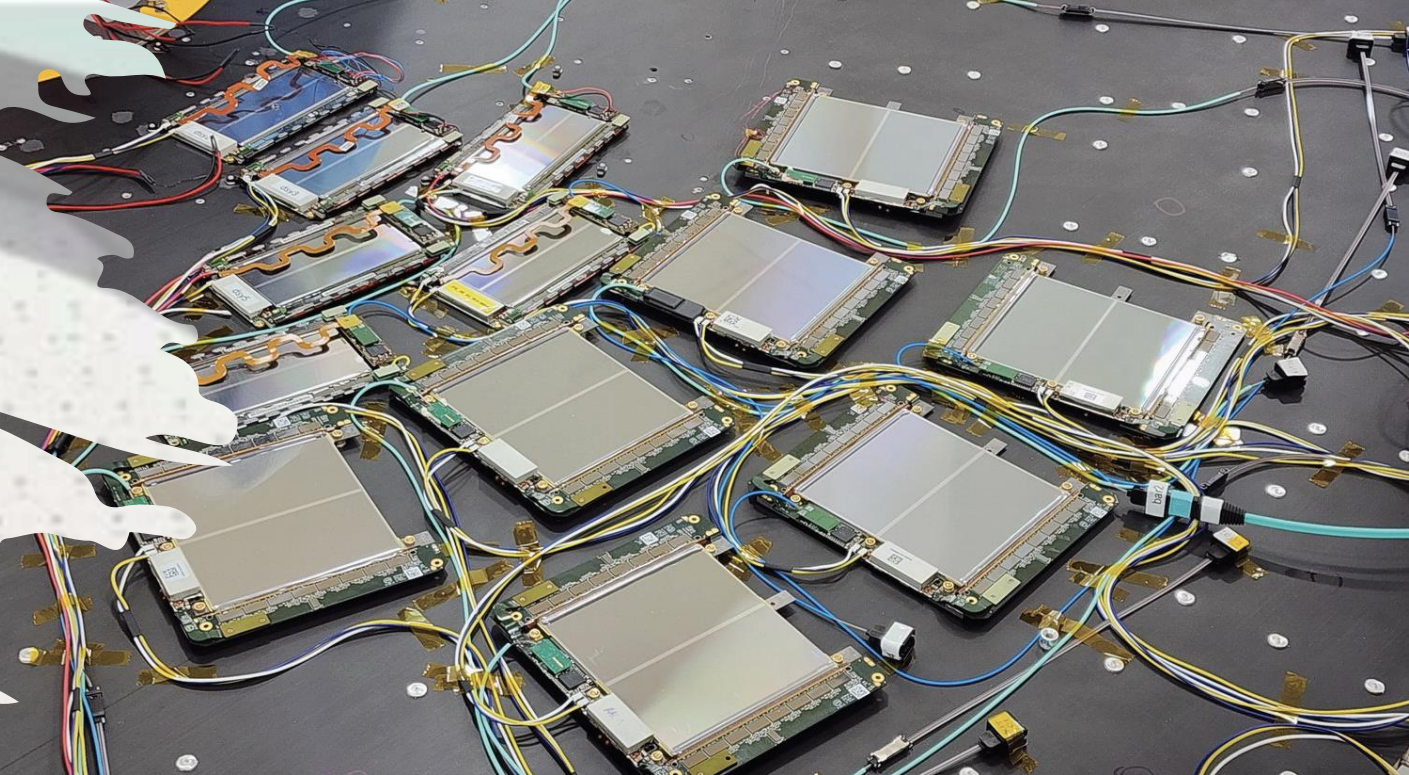
Strips & Pixel
All n-in-p

Barrel stave loaded with 14 modules per side



CMS Phase II

- Outer Tracker modules in final configuration
 - n-in-p
- Pixel Tracker module
 - n-in-p
- High Granularity Calorimeter
 - n-in-p (8 in.)



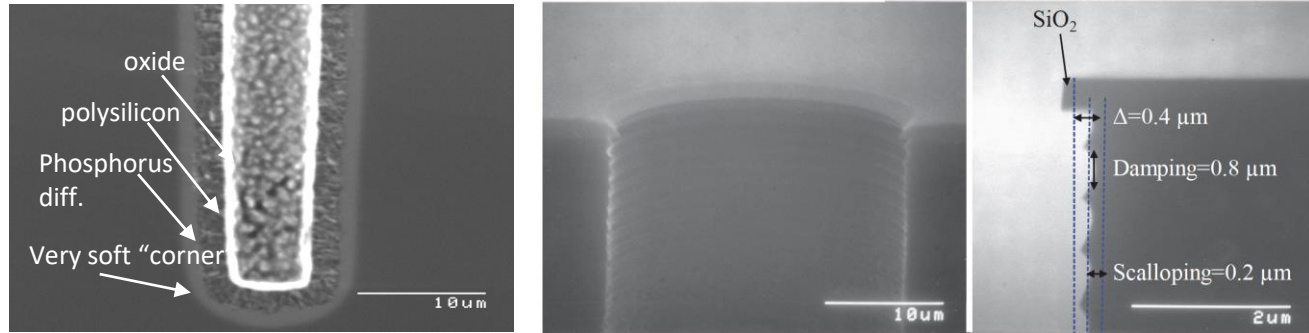
First RD50 workshop

Silicon 3D radiation sensors: general characteristics; irradiation test results

Sherwood Parker and Christopher Kenney (LBL Berkeley, USA)

■ Deep reactive-ion etching (DRIE)

Photos:
Courtesy of CNM-IMB (CSIC), Barcelona



→ ATLAS APPRECIATES
- LO AS FIRST USE-CASE

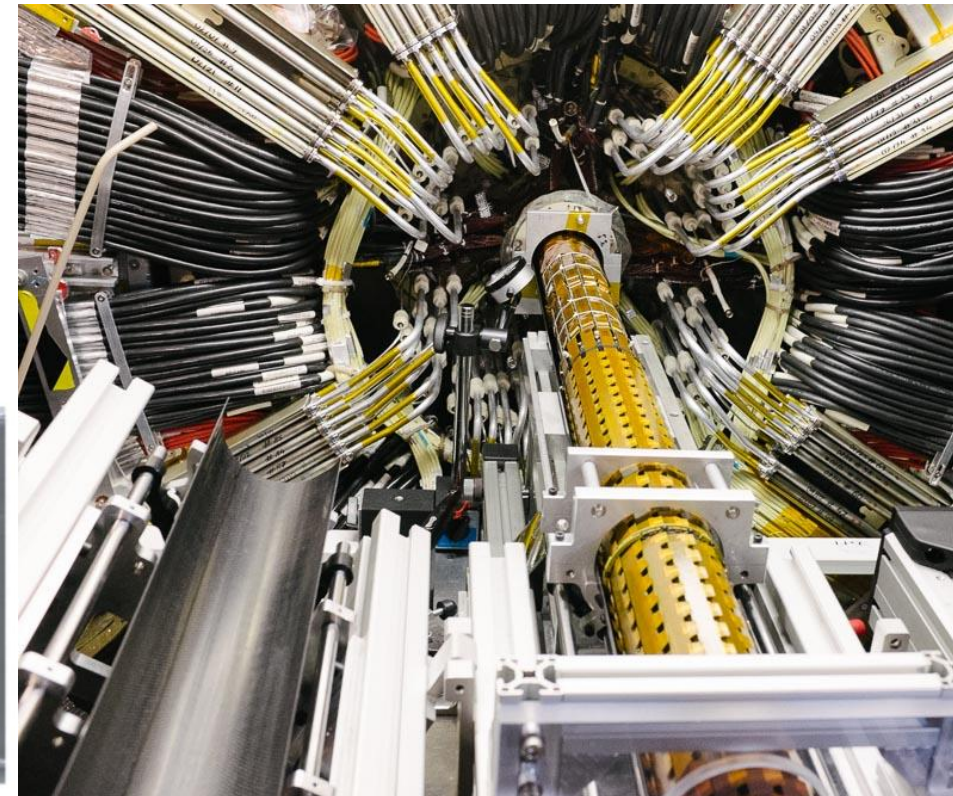
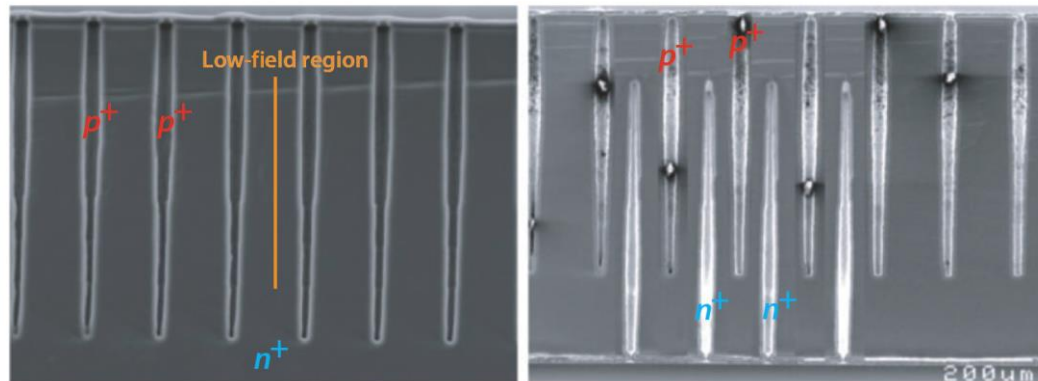
Evolution of 3D implementation

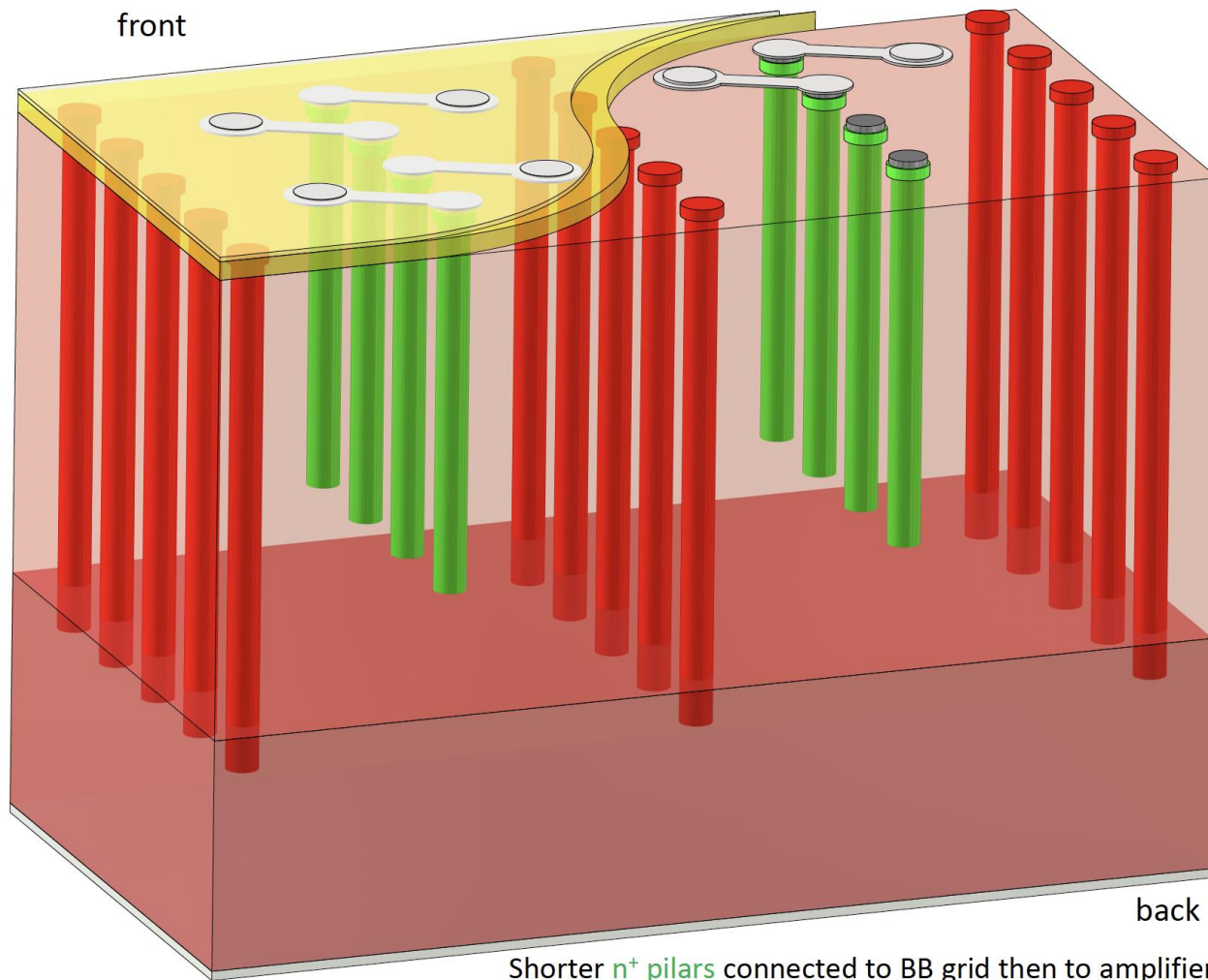
■ Double or single type?

■ Double or single sided?

■ Full 3D-pass-through?

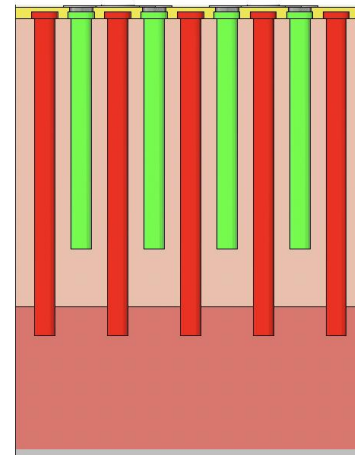
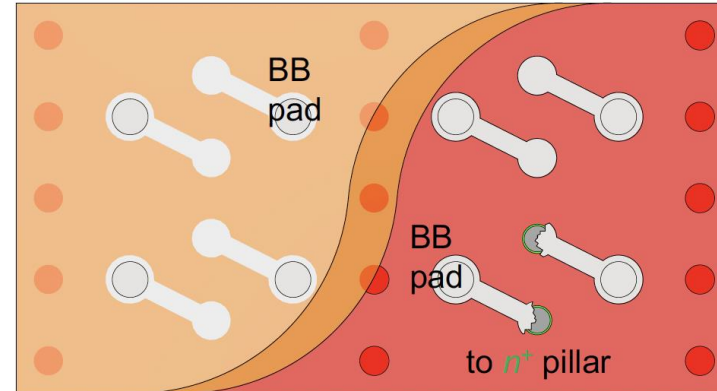
■ Thin or thick?



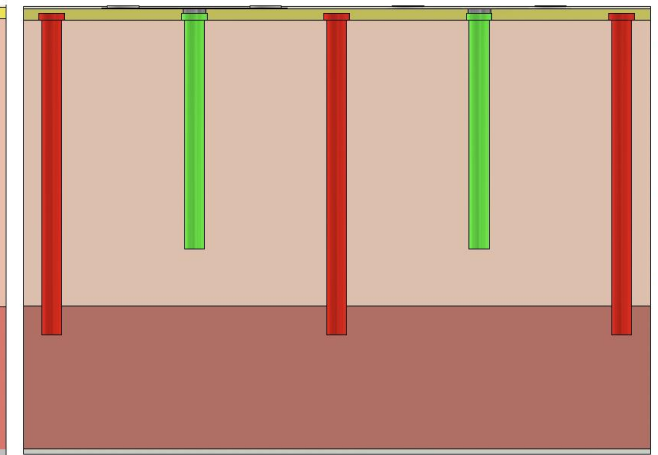


Shorter n^+ pillars connected to BB grid then to amplifier
 Long p^+ pillars connected common low resistive (Ωm) substrate on back

25x100 μm^2 pixel cell size – n^+ pillar spacing
 Metal routing to a 50x50 μm^2 bump bonding (BB) pad grid
 passivation on top of routing, only pads open



Side view 25 μm spacing

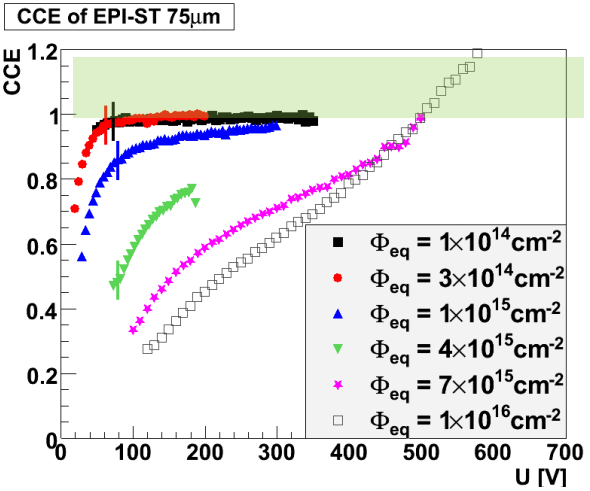


Side view 100 μm spacing

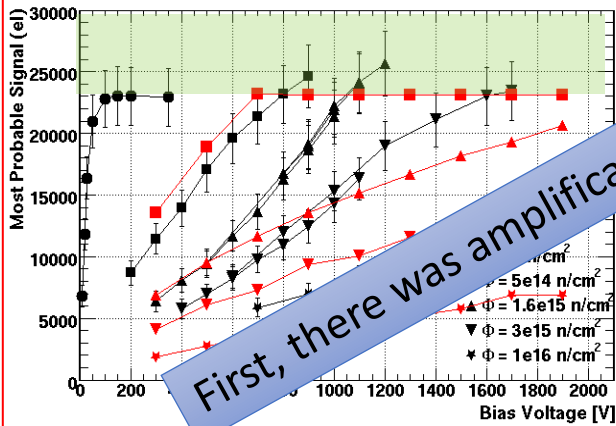
p bulk 150 μm
 p^{++} low Ωm wafer

Fig. 2.27 The final HL-LHC 3D sensor layout with $25 \times 100 \mu m^2$ pixel cells – 1E-scheme

Joern Lange, RD50 2009, EPI

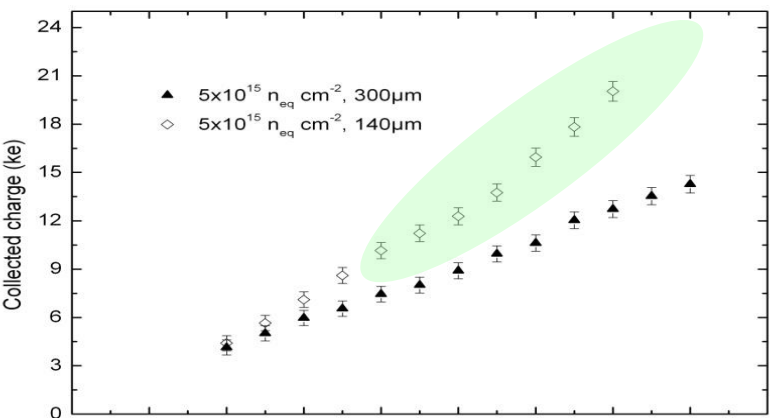


I. Mandić et al., RESMDD 2008



First, there was amplification

G. Casse, Vertex 2009, n-in-p



Then there was head scratching



Then we had daring ideas 'to use' the amplification



Then we re-invented reach-through diodes – optimised them – and called them LGADs

IEEE TRANSACTIONS ON ELECTRON DEVICES, JUNE 1972

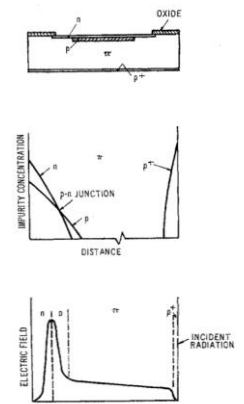
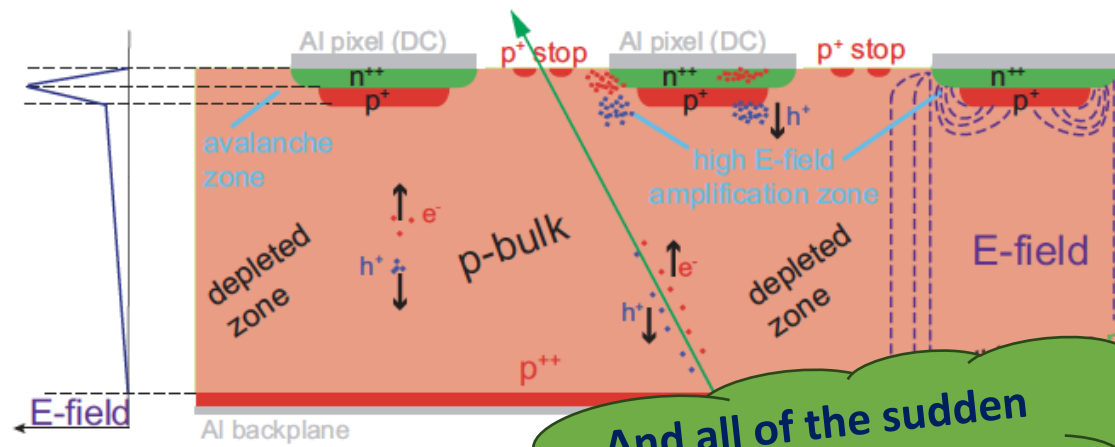
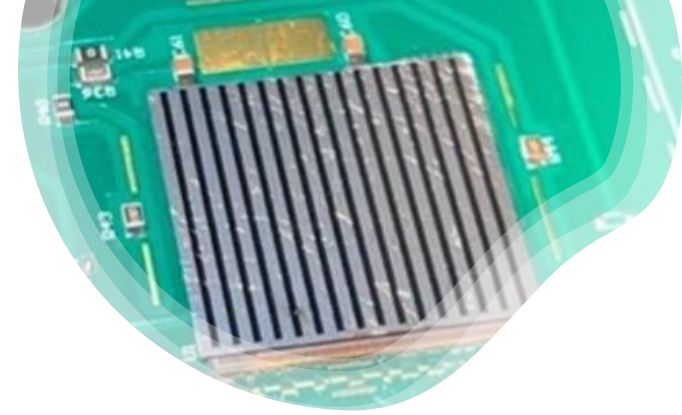
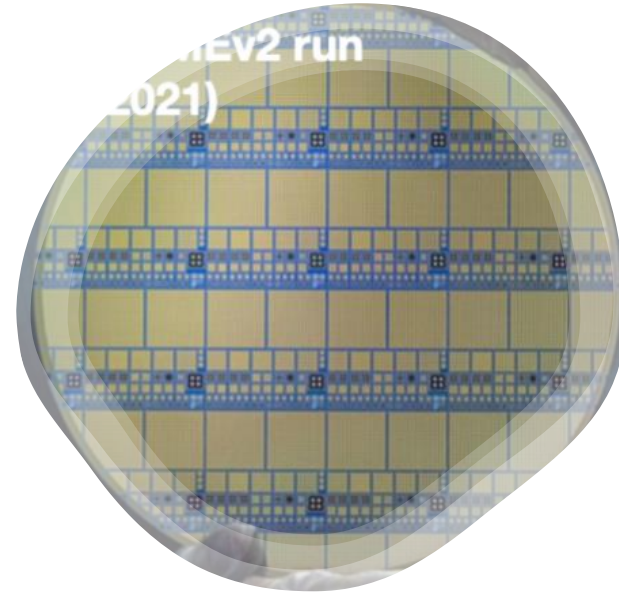
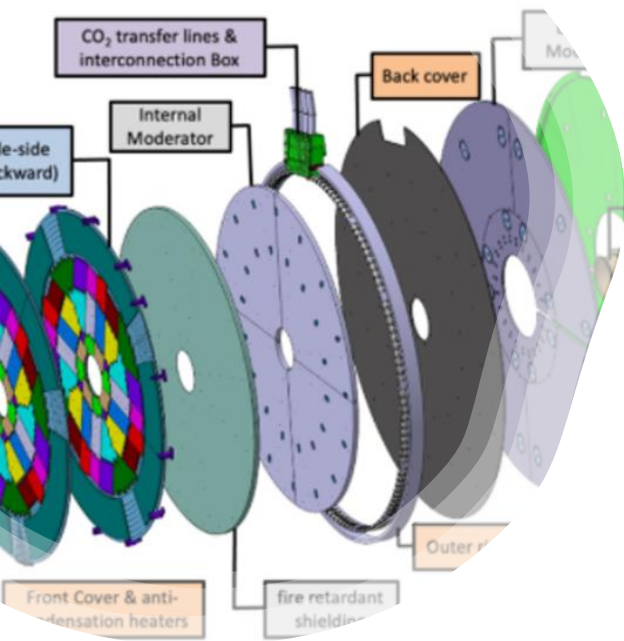


Fig. 1. Sketches of reach-through avalanche-diode structure, impurity-concentration profile, and electric-field distribution.

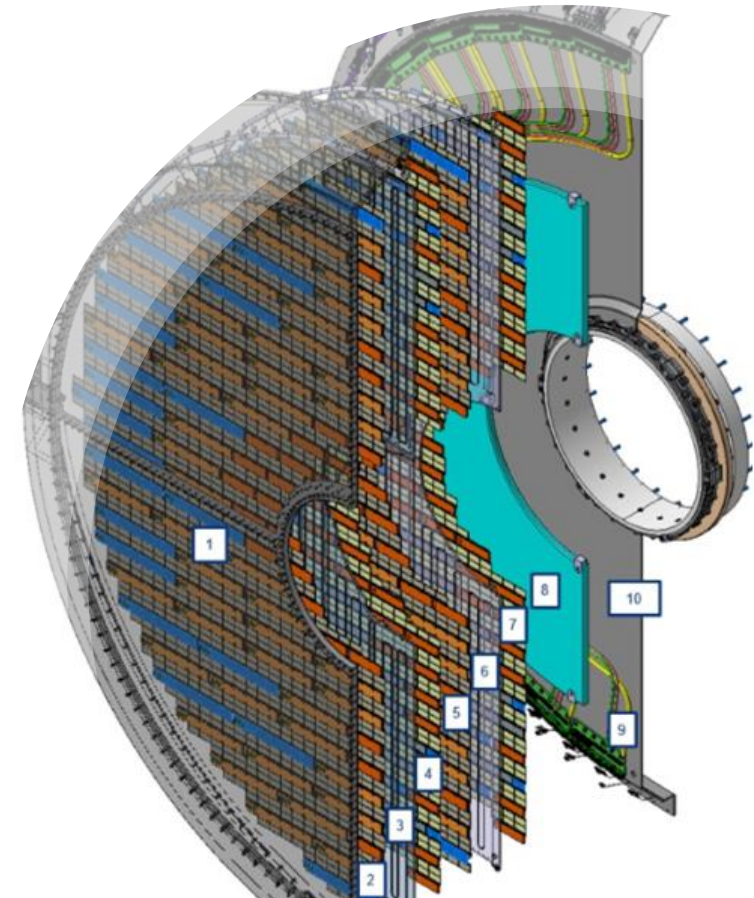


And all of the sudden CARBON IS GOOD



ATLAS and CMS will equip their endcaps with LGADs to associate a timestamp to their tracks – 4D

Let's put LGADs at work



LHCb – LS4

- Precision timing is key
... and do not forget spatial precision
→ We need an upgrade on LGADs

And I know of at least one additional LHC experiment having thoughts to use such 'upgrades'



From Abe Seiden, Hartmut Sadrozinski and Nicolo Cartiglia pioneers on LGADs:

I'm wondering if we can do both measurements (space and time) in one object, a silicon detector with very good timing resolution.

We thought it was a dumb question...but over lunch, we jotted down some numbers.

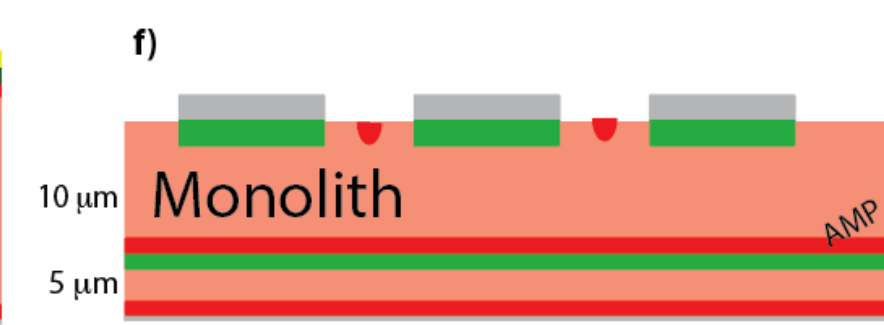
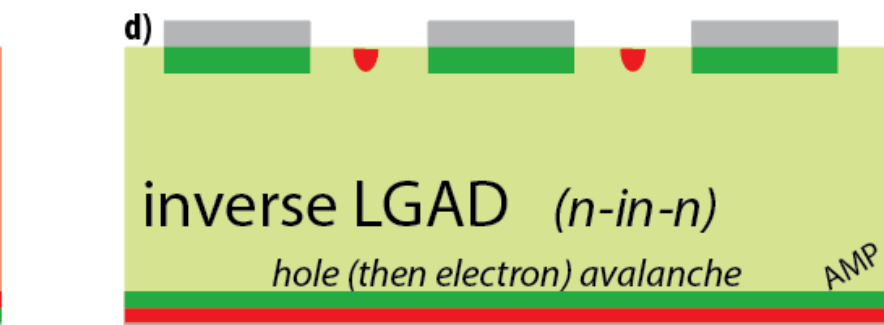
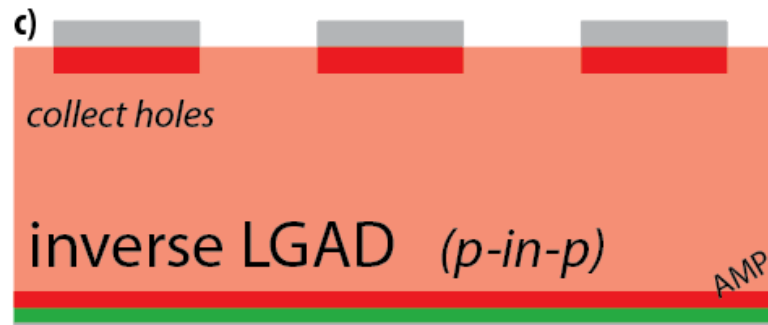
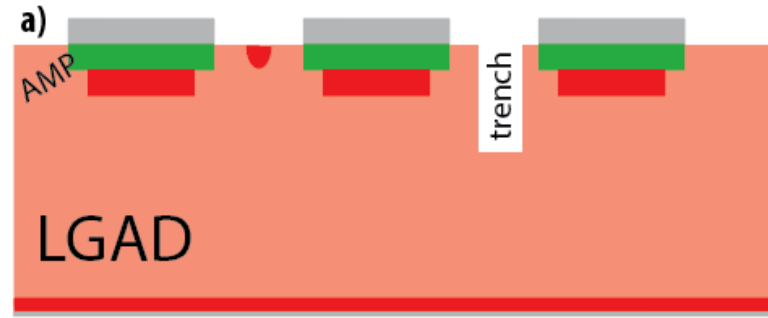
... The main question is understanding the gain in silicon sensors

Watch out – people from different experiments working together...
-- Thanks for the framework – and the BLUR



In summary, I present THE ZOO

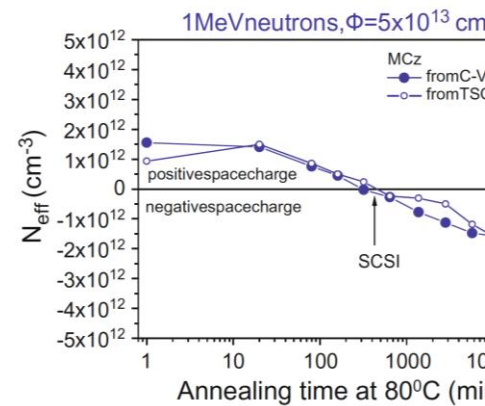
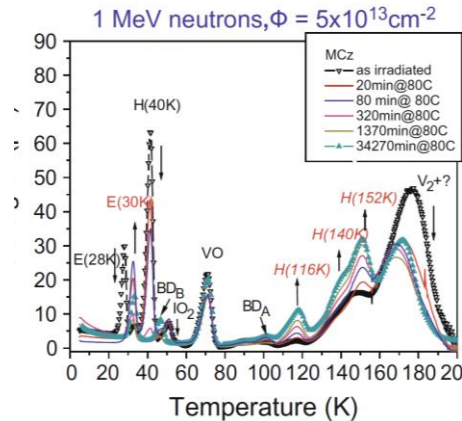
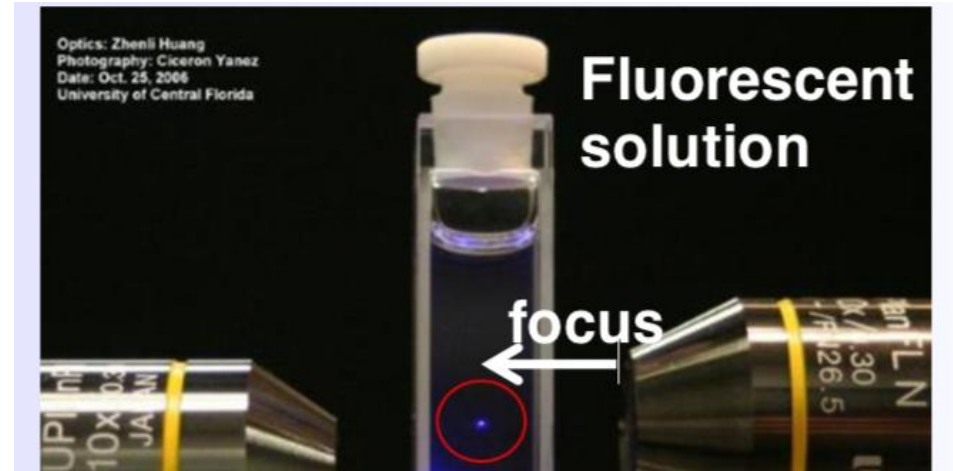
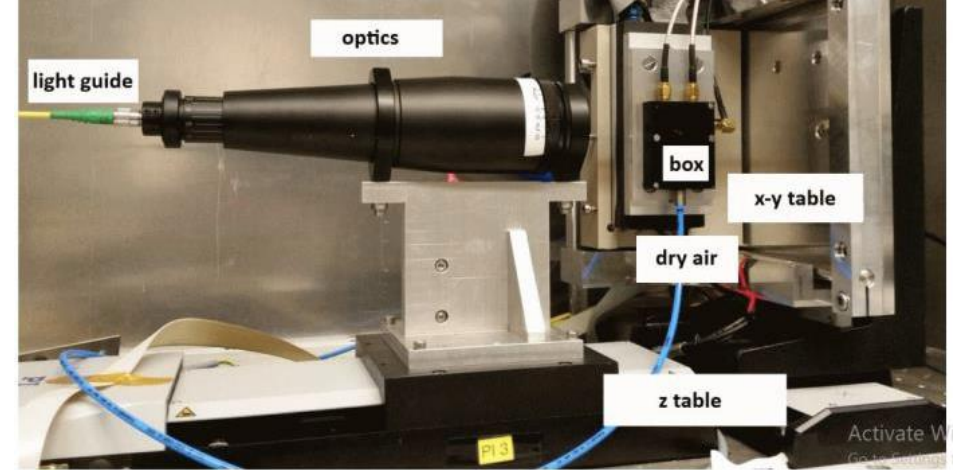
Anybody up for a bet?



or the new DC-RSD (DC-LGAD)

Tools, spearheaded, improved, standardized, distributed by RD50
 - ANYHOW, THEY CHANGED OUR UNDERSTANDING SIGNIFICANTLY

- TCT – front, back, edge and then TPA-TCT
- TSC, DLTS
- IV, CV
- Alibava
- Many more ...
- Custom simulation tools
- Radiation defect models, Hamburg Model





THANK YOU RD50

- **IT WAS FUN**
- **TOGETHER RD50 AND EXPERIMENTS**
 - **WE REALISED MARVELLOUS DETECTORS**
- **MORE TO COME BASED ON ALL THE GOOD WORK OF RD50**